

CENTER FOR POWER OPTIMIZATION OF ELECTRO-THERMAL SYSTEMS

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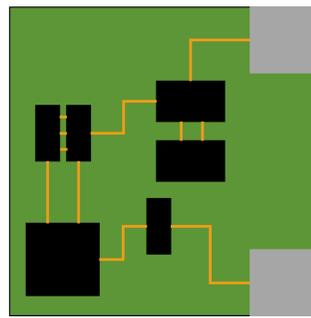


Heat Spreader Design for Electrical Optimization

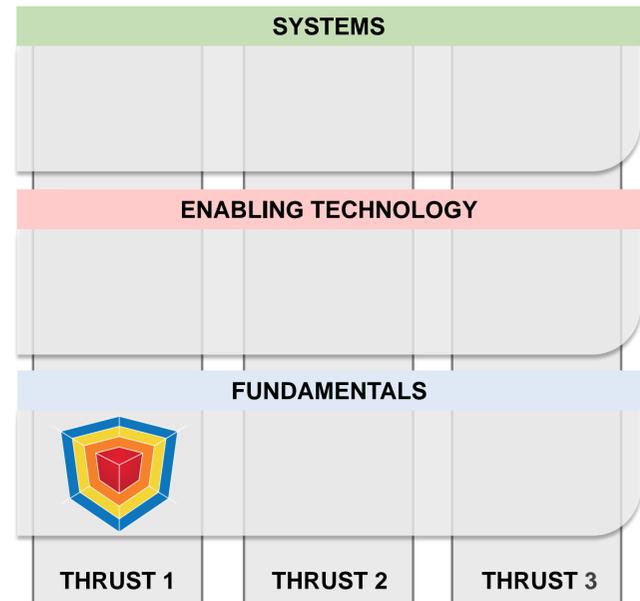
Danny J. Lohan (UIUC), Ercan M. Dede (TOYOTA), James T. Allison (UIUC)

How can a passive heat spreader be designed to augment circuit performance metrics?

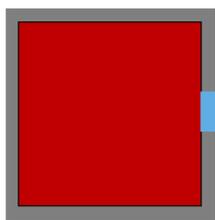
- Heat spreaders are traditionally designed after the electrical circuit for sole purpose of extracting heat.
- This investigation explores different topology optimization formulations to design heat spreaders for circuits
- By optimizing objectives that correlate directly to electrical performance, unconventional designs are discovered that may increase performance.



Sample Circuit



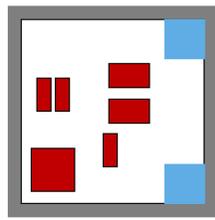
SIMP Based Topology Optimization of Passive Heat Spreaders



$$\min_{\rho} \int TF$$

$$s. t. \begin{aligned} T &\leq T_{min} \\ V &\leq V_p \\ R &\leq R_{min} \end{aligned}$$

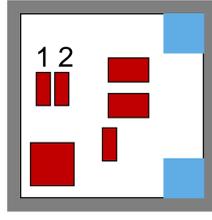
"Minimize the sum of the temperature on the domain"



$$\min_{\rho} \int TF$$

$$s. t. \begin{aligned} T &\leq T_{min} \\ V &\leq V_p \\ R &\leq R_{min} \end{aligned}$$

"Minimize the sum of the temperature on the heating components"



$$\min_{\rho} (T_1 - T_2)$$

$$s. t. \begin{aligned} T &\leq T_{min} \\ V &\leq V_p \\ R &\leq R_{min} \end{aligned}$$

"Minimize the temperature of 1 and maximize the temperature of 2"

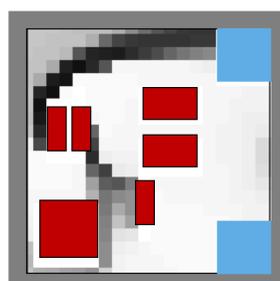
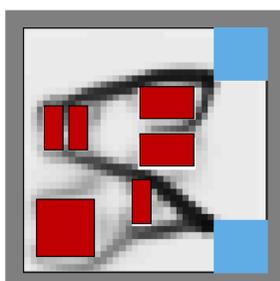
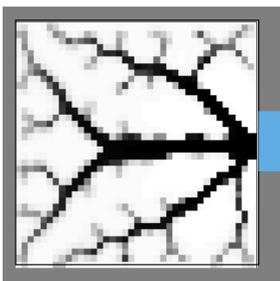
- Consider the following metrics for an RLC circuit:

$$\text{Loss} = I^2 R(t), \quad \text{Damping} = \frac{R(t)\sqrt{C}}{2\sqrt{L}}$$

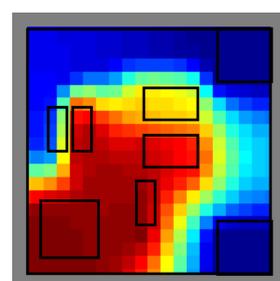
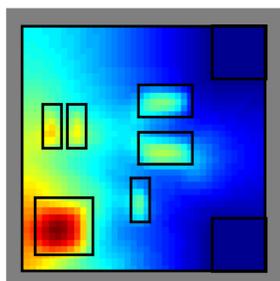
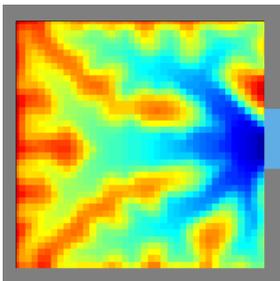
- Both loss and damping are functions of temperature dependent resistance, but they are competing objects.
- By designing the temperature response on the domain, electrical performance may be augmented

Preliminary Topology Optimization Solutions

Topology



Temperature



Conclusions and Future Work

- Topology optimization was successfully used to design temperature maps for electrical performance metrics
- Future work will look to evaluate the magnitude of these changes on circuit performance

Acknowledgements

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